

Amendments To Claims:

This listing of claims will replace all prior versions, and listings, of claims in the application:

Listing of Claims:

Claims 1-6 (Cancelled)

7. (Withdrawn) A substrate cutting system according to claim 6, wherein the substrate supporting section is a plurality of cylindrical rollers.

8. (Withdrawn) A substrate cutting system according to claim 7, comprising at least one rotation transmission means for rotating the plurality of cylindrical rollers in accordance with the movement of the scribing device guide body.

9. (Withdrawn) A substrate cutting system according to claim 7, comprising a control section for rotating the plurality of cylindrical rollers in accordance with the movement of the scribing device guide body.

Claims 10-15 (Cancelled)

16. (Withdrawn) A substrate cutting system according to claim 15, wherein the substrate supporting section is a plurality of cylindrical rollers.

17. (Withdrawn) A substrate cutting system according to claim 16, comprising at least one rotation transmission means for rotating the plurality of cylindrical rollers in accordance with the movement of the scribing device guide body.

18. (Withdrawn) A substrate cutting system according to claim 16, comprising a control section for rotating the plurality of cylindrical rollers in accordance with the movement of the scribing device guide body.

Claim 19 – 59 (Cancelled)

60. (currently amended) A substrate cutting system, comprising:
a pair of scribing line forming means arranged facing each other;

a pair of scribing devices for supporting the pair of scribing line forming means such that one of the pair of scribing line forming means moves on a first surface of a substrate in an X axis direction and the other of the pair of scribing forming means moves on a second surface of the substrate in the X axis direction;

a scribing device guide body for supporting the pair of scribing devices such that the pair of scribing devices moves in a Y axis direction; and

a substrate supporting means for supporting the substrate in an X-Y plane such that the pair of scribing line forming means scribes the first surface of the substrate and the second surface of the substrate;

wherein the substrate supporting means has a plurality of belts supporting the substrate, wherein the plurality of belts are driven at a speed the same as that of the substrate supporting means in a direction opposite to the moving direction of the substrate supporting means;

wherein the substrate supporting means is ~~placed in~~ located on both sides of ~~Y-axis direction of the pair of scribing devices relative to the Y direction, [[;]]~~ and is configured to be relatively movable ~~[[to]]~~ in the Y axis direction relative to the substrate, and wherein the pair of scribing devices forms a scribing line by moving ~~[[to]]~~ in the Y axis direction relative to the substrate in conjunction with the substrate supporting device;

wherein the substrate supporting means comprises:

a substrate supporting device supported by the scribing device guide body, wherein the substrate supporting device moves in the Y axis direction in conjunction with the pair of scribing devices, and

a fixing device for fixing the substrate in the X-Y plane;

at least one rotation transmission means for circling the plurality of belts in accordance with the movement of the scribing device guide body.

61-65. (cancelled)

66. (currently amended) A substrate cutting method, comprising:

forming, by a pair of scribing devices, a scribing line by moving in the Y axis direction relative to the substrate in conjunction with a substrate supporting device;

driving a plurality of belts at a speed the same as that of a substrate supporting means in a direction opposite to the moving direction of the substrate supporting means; and

circling, by at least one rotation transmission means, the plurality of belts in accordance with the movement of a scribing device guide body,

wherein a pair of scribing line forming means are arranged facing each other;

wherein the [[a]] pair of scribing devices for supporting support the pair of scribing line forming means such that one of the pair of scribing line forming means moves on a first surface of a substrate in an X axis direction and the other of the pair of scribing line forming means moves on a second surface of the substrate in the X axis direction;

ascribing wherein the scribing device guide body for supporting supports the pair of scribing devices such that the pair of scribing devices moves in a Y axis direction; and

wherein the [[a]] substrate supporting means for supporting supports the substrate in an X-Y plane such that the pair of scribing line forming means scribes the first surface of the substrate and the second surface of the substrate,

wherein the substrate supporting means has the plurality of belts supporting the substrate,

wherein the substrate supporting means is located on both sides of the pair of scribing devices relative to the Y direction and is configured to be relatively movable in the Y axis direction relative to the substrate.;

wherein the substrate supporting means comprises:

the substrate supporting device supported by the scribing device guide body,

wherein the substrate supporting device moves in the Y axis direction in conjunction with the pair of scribing devices, and

a fixing device for fixing the substrate in the X-Y plane.

~~wherein, in a substrate cutting system, that the substrate supporting means is placed on both sides of Y axis direction of the pair of scribing devices relative to the Y direction, and is configured to be relatively movable in the Y axis direction relative to the substrate in conjunction with the pair of scribing devices, a method for cutting the substrate for forming and is configured to form a scribing line by moving the pair of scribing devices in the Y axis direction relative to the substrate in conjunction with the substrate supporting device.~~

67. (cancelled)